

N- and P- Channel 20 V (D-S) MOSFET

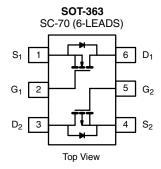
PRODUCT SUMMARY						
	V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)			
N-Channel		0.090 at V _{GS} = 4.5 V	3.28			
	20	0.110 at V _{GS} = 2.5 V	2.13			
		0.130 at V _{GS} = 1.8 V	1.50			
		0.155 at V _{GS} = - 4.5 V	- 2.80			
P-Channel	- 20	0.190 at V _{GS} = - 2.5 V	- 1.81			
		0.220 at V _{GS} = - 1.8 V	- 1.15			

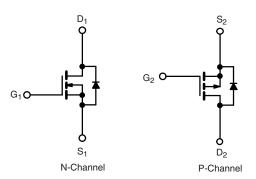
FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFETs: 1.8 V Rated
- Thermally Enhanced SC-70 Package
- Fast Switching
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

Load Switch for Portable Devices





ABSOLUTE MAXIMUM RATINGS $T_A = 25 \text{ °C}$, unless otherwise noted								
Parameter			N-Channel		P-Channel			
		Symbol	5 s	Steady State	5 s	Steady State	Unit	
Drain-Source Voltage		V _{DS}	20		- 20		V	
Gate-Source Voltage		V _{GS}	± 20		± 20		v	
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 25 °C	I _D	3.28	3.03	- 2.80	- 2.58	А	
	T _A = 85 °C		2.12	1.81	- 1.72	- 1.53		
Pulsed Drain Current		I _{DM}	9.5		- 8.5		А	
Continuous Source Current (Diode Conduction) ^a		۱ _S	2.61	2.48	- 1.61	-1.48		
Maximum Power Dissipation ^a	T _A = 25 °C	Р	1.24	1.17	1.10	0.97	W	
	T _A = 85 °C	P _D	0.88	0.75	0.66	0.5		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150				°C	

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^a	t ≤ 5 s	Р	130	170			
Maximum Junction-to-Ambient	Steady State	R _{thJA}	170	220	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	80	100			

Notes:

a. Surface mounted on 1" x 1" FR4 board.

SPECIFICATIONS $T_J = 25 \text{ °C}$, unless otherwise noted								
Parameter	Symbol	Test Conditions		Min.	Тур.	Max.	Unit	
Static								
Gate Threshold Voltage	V	$V_{DS} = V_{GS}$, $I_D = 100 \ \mu A$	N-Ch	0.45		1	v	
	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -100 \ \mu A$	P-Ch	- 0.45		1	v	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 8 V$	N-Ch			± 100	nA	
			P-Ch			± 100		
Zero Gate Voltage Drain Current	h	$V_{DS} = 16 \text{ V}, V_{GS} = 0 \text{ V}$	N-Ch			1		
		$V_{DS} = -16 \text{ V}, V_{GS} = 0 \text{ V}$	P-Ch			- 1	μA	
Zero Gale Voltage Drain Gurrent	I _{DSS}	V_{DS} = 16 V, V_{GS} = 0 V, T_{J} = 85 °C				5	μΑ	
		V_{DS} = - 16 V, V_{GS} = 0 V, T_{J} = 85 °C	P-Ch			- 5		
On-State Drain Current ^a	1-4-5	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}$	N-Ch	2			А	
	I _{D(on)}	$V_{DS} \leq$ - 5 V, V_{GS} = - 4.5 V	P-Ch	- 2				
		V_{GS} = 4.5 V, I _D = 2.55 A	N-Ch		0.090		Ω	
		V _{GS} = - 4.5 V, I _D = - 1.85 A	P-Ch		0.155			
Drain-Source On-State Resistance ^a	Beau	$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 1.55 \text{ A}$	N-Ch		0.110			
	R _{DS(on)}	V_{GS} = - 2.5 V, I _D = - 1.35 A	P-Ch		0.190		52	
		V_{GS} = 1.8 V, I _D = 0.50 A	N-Ch		0.130			
		$V_{GS} = -1.8 \text{ V}, \text{ I}_{D} = -0.50 \text{ A}$	P-Ch		0.220			
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1.13 \text{ A}$	N-Ch		2.6		s	
Forward Transconductance"		$V_{DS} = -10$ V, $I_{D} = -0.88$ A	P-Ch		1.5			
Diode Forward Voltage ^a	V _{SD}	$I_{\rm S} = 0.48$ A, $V_{\rm GS} = 0$ V	N-Ch		0.8	1.2	v	
-	• SD	$I_{\rm S}$ = - 0.48 A, $V_{\rm GS}$ = 0 V	P-Ch		- 0.8	- 1.2	v	
Dynamic ^b							,	
Total Gate Charge	Qg	N Channel	N-Ch		1.25	2		
Iotal Gate Charge		N-Channel $V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 2.55 \text{ A}$	P-Ch		1.2	1.8	nC	
Gate-Source Charge	Q _{gs}		N-Ch		0.21			
Cale Course Charge	∝gs	P-Channel V _{DS} = - 10 V, V _{GS} = - 4.5 V, I _D = - 0.88	P-Ch		0.3			
Gate-Drain Charge	Q _{gd}	$v_{DS} = -10 v, v_{GS} = -4.5 v, i_D = -0.86$	N-Ch		0.3			
	Ggd		P-Ch		0.21			
Turn-On Delay Time	t _{d(on)}		N-Ch		15	25		
		N-Channel	P-Ch		18	30	-	
Rise Time	t _r	$V_{DD} = 10 \text{ V}, \text{ R}_{L} = 20 \Omega$	N-Ch		22	35		
		$\text{I}_\text{D} \cong$ 0.5 A, V_GEN = 4.5 V, R_g = 6 Ω	P-Ch		25	40		
Turn-Off Delay Time	t _{d(off)}	P-Channel	N-Ch		25	40	ns	
		$V_{DD} = -10 \text{ V}, \text{ R}_{L} = 20 \Omega$	P-Ch		15	25		
Fall Time	t _f	$I_D \cong$ - 0.5 A, V_{GEN} = - 4.5 V, R_g = 6 Ω	N-Ch		12	20		
			P-Ch		12	20		
Reverse Recovery Time	+	I _F = 0.48 A, dl/dt = 100 A/μs	N-Ch		30	60		
neverse Recovery Time	t _{rr}	$r_{\rm F} = 0.40$ Å, di/dl = 100 Å/µS	P-Ch		30	60		

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Notes:

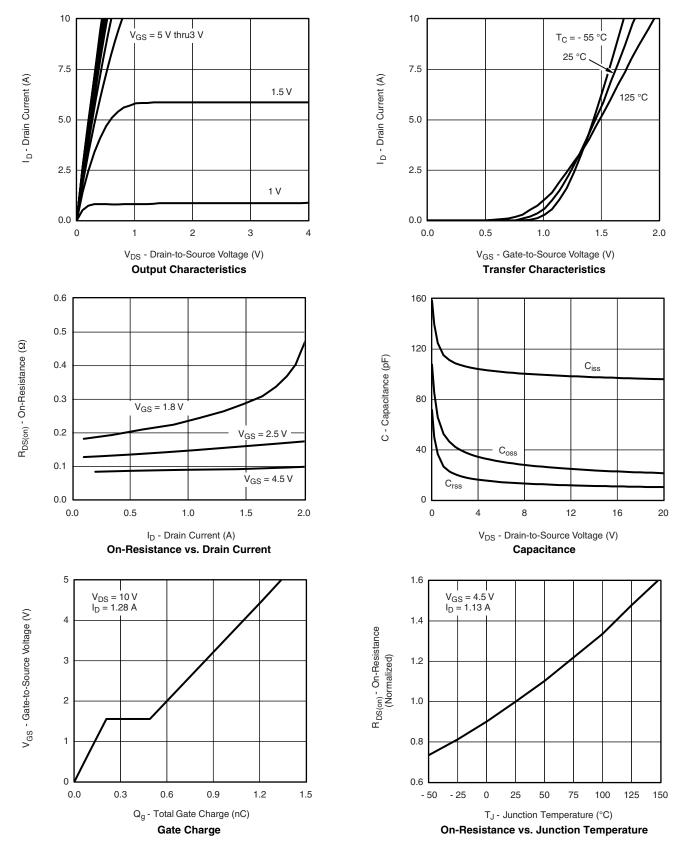
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

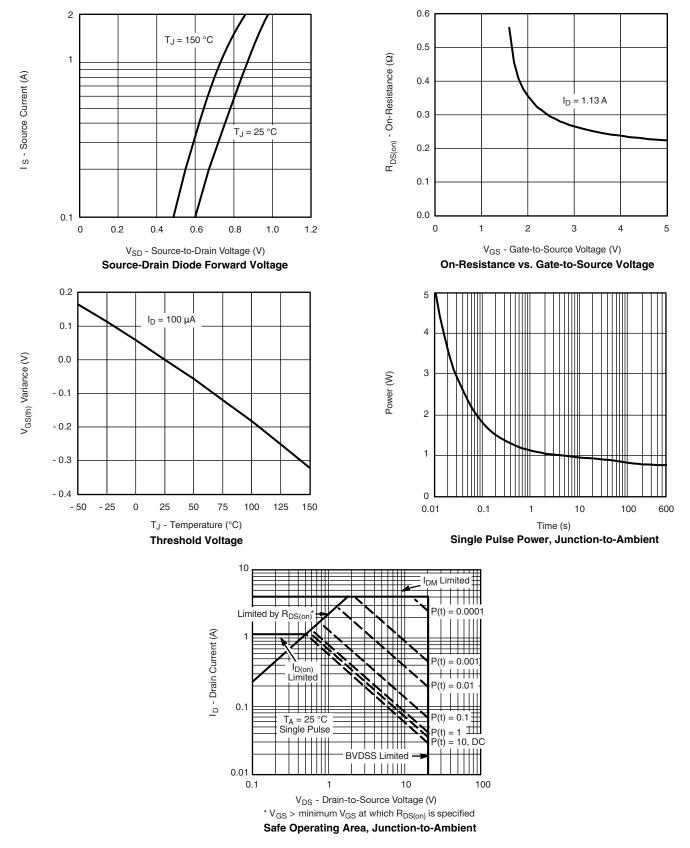


N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

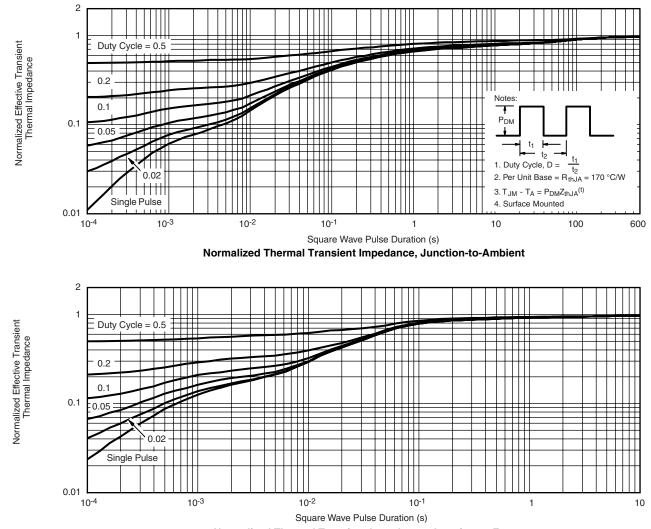










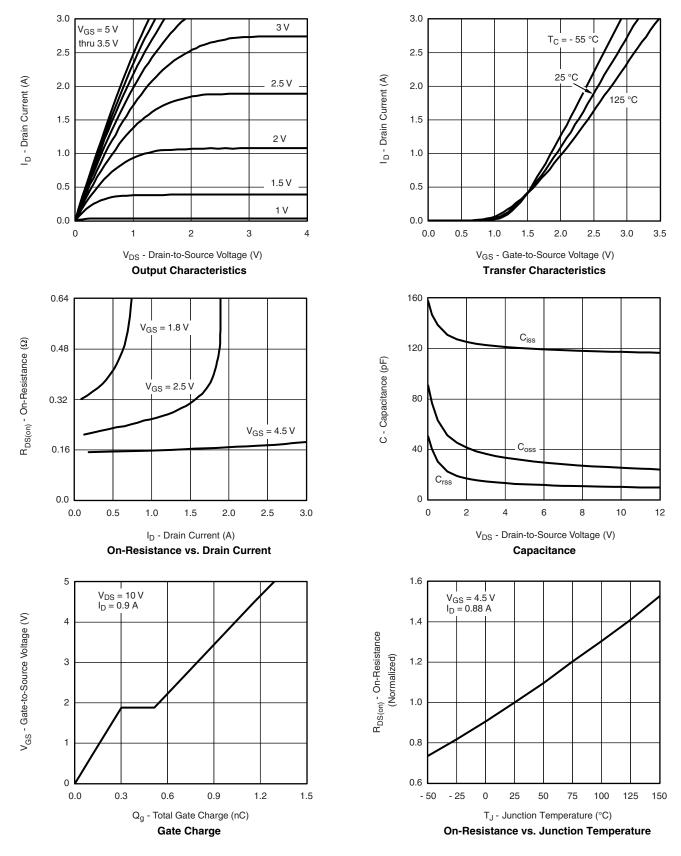


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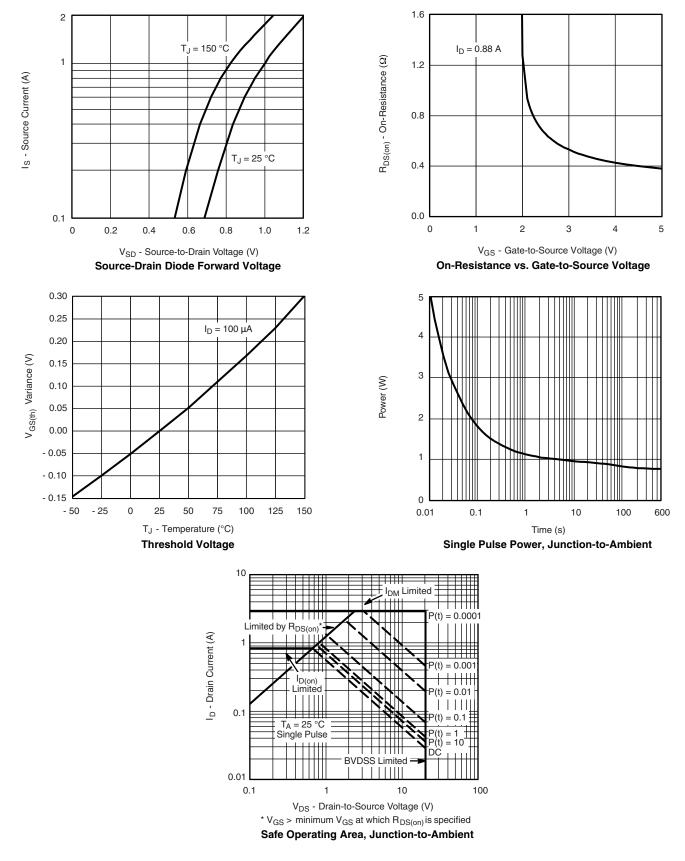


P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

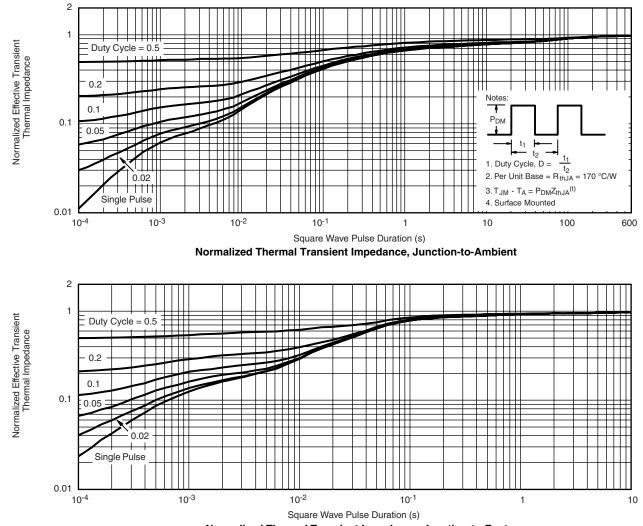




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P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

Normalized Thermal Transient Impedance, Junction-to-Foot



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